



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 2818
Examiner: Mai-Huong Tran

In Re PATENT APPLICATION Of:

Applicant(s): KER et al.
Serial No.: 09/935,796
Filed: August 24, 2001
For: BONDING PAD STRUCTURE TO
AVOID PROBING DAMAGE
Docket No.: SUND 218

#5/Q
marsha
6/27/03
AMENDMENT

June 18, 2003

Mail Stop - Non-Final Office Action

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This amendment is filed in response to the Examiner's Action mailed on March
18, 2003. Please amend the above-identified application as follows:

RECEIVED
JUN 19 2003
TECHNOLOGY CENTER 2800

FEE ENCLOSED: \$ *4*
Please charge any further
fee to our Deposit Account
No. 18-0002